

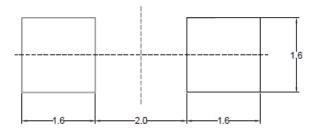
SPECIFICATIONS CS126AG1C

Cathode Mark Resin 0.6 Soldering Terminal

Notes:

- 1. All dimensions are in millimeters (inches);
- 2. Tolerances are ±0.1mm unless otherwise noted.

Recommended Solder Pad



Note: The tolerances unless mentioned is ±0.1mm,Angle±0.5. Unit=mm.

Part Number		Chip Material	Color of Emission	Lens Type	Viewing Angle		
	CS126AG1C	GaP	Green	Water Clear	140°		





ABSOLUTE MAXIMUM RATINGS

(TA=25°C)

Parameter	Symbol	Value	Unit	
Forward current	If	25	mA	
Reverse current @ 5V	Ir	10	μA	
Power dissipation	Pd	65	mW	
Operating temperature range	Topr	-40~+85	°C	
Storage temperature range	Tstg	-40~+90	°C	
Peak pulsing current (1/10 duty f= 10KHz)	lfp	120	mA	
Soldering Temperature	T _{SOL}	Max 260°C for 5 sec Max		

OPTICAL-ELECTRICAL CHARACTERISTICS

(TA=25°C)

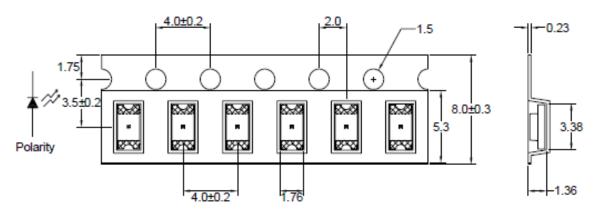
	Symbol	T 10 III	Value			11. 11
Parameter		Test Condition	Min	Тур	Max	Unit
Wavelength at peak emission	λpeak	I _F = 20mA	-	565	1	nm
Spectral half bandwidth	Δλ	I _F = 20mA	ı	30	ı	nm
Dominant wavelength	λD	I _F = 20mA	-	573	ı	nm
Forward Voltage	Vf	I _F = 20mA	1.7	-	2.6	V
Luminous intensity	lv	I _F = 20mA	5.0	12.5	ı	mcd
Viewing angle at 50% Iv	20 ½	I _F = 20mA	ı	14	1	Deg

^{*}NOTE: 1. The forward voltage data did not including $\pm 0.1 \text{V}$ tolerance 2. The luminous intensity data did not including $\pm 15\%$ tolerance



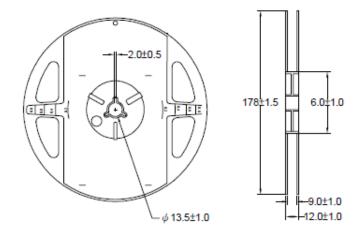


DIMENSIONS OF TAPE (Unit: mm)



NOTE: The tolerances unless mentioned is ± 0.1 mm, Angle ± 0.5 . Unit = mm.

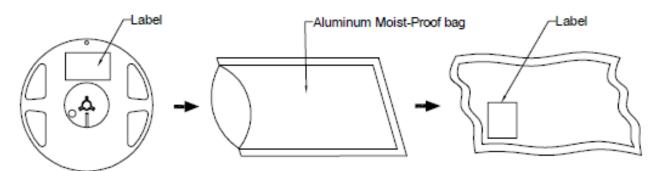
REEL DIMENSIONS



NOTES:

- 1. Empty component pockets are sealed with top cover tape;
- 2. The maximum number of missing lamps is two;
- 3. The cathode is oriented towards the tape sprocket hole.
- 4. 3,000pcs/Reel

PACKAGING SPECIFICATION







OPTICAL CHARACTERISTIC CURVES

Fig.1 Forward current vs. Forward Voltage

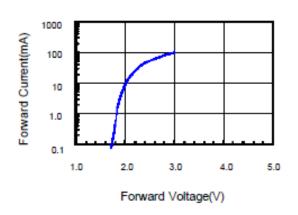
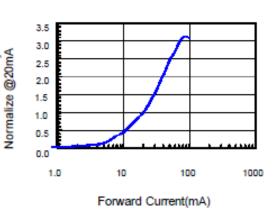


Fig.2 Relative Intensity vs. Forward Current



Relative Intensity

Fig.3 Forward Voltage vs. Temperature

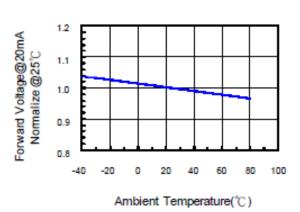


Fig.4 Relative Intensity vs. Temperature

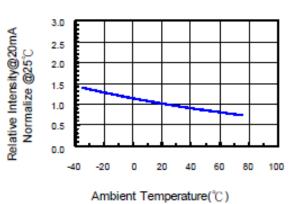


Fig.5 Relative Intensity vs. Wavelength

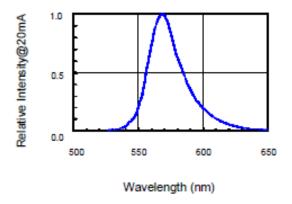
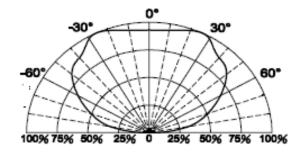


Fig.6 Directive Radiation





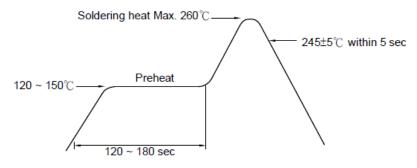


SOLDERING CONDITIONS – LAMP TYPE LED

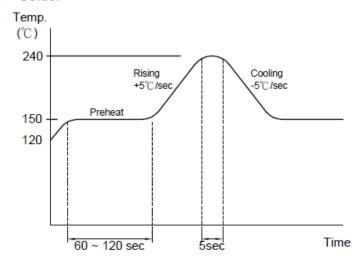
1. Hand Solder

Basic spec is $\leq 280^{\circ}$ C 3 sec one time only.

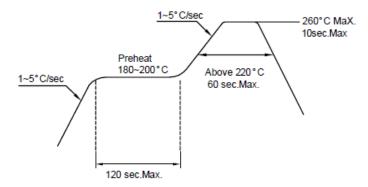
2. Wave Solder



3-1. LEAD Reflow Solder



3-2 PB-Free Reflow Solder



Reflow Soldering should not be done more than two times.

